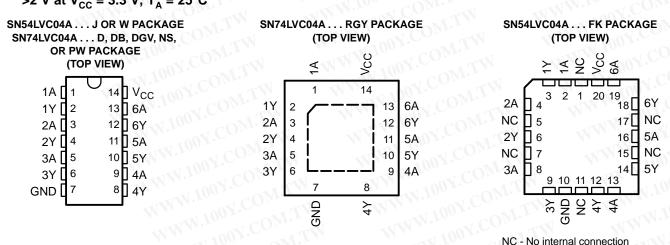


FEATURES

- Operate From 1.65 V to 3.6 V
- Specified From -40°C to 85°C, -40°C to 125°C, and -55°C to 125°C
- Inputs Accept Voltages to 5.5 V
- Max t_{pd} of 4.5 ns at 3.3 V
- Typical V_{OLP} (Output Ground Bounce)
 <0.8 V at V_{CC} = 3.3 V, T_A = 25°C
- Typical V_{OHV} (Output V_{OH} Undershoot)
 >2 V at V_{CC} = 3.3 V, T_A = 25°C

- Latch-Up Performance Exceeds 250 mA Per JESD 17
- ESD Protection Exceeds JESD 22
 - 2000-V Human-Body Model (A114-A)
 - 200-V Machine Model (A115-A)
 - 1000-V Charged-Device Model (C101)



DESCRIPTION/ORDERING INFORMATION

The SN54LVC04A hex inverter contains six independent inverters designed for 2.7-V to 3.6-V V_{CC} operation, and the SN74LVC04A hex inverter contains six independent inverters designed for 1.65-V to 3.6-V V_{CC} operation. The 'LVC04A devices perform the Boolean function $Y = \overline{A}$.

Inputs can be driven from either 3.3-V or 5-V devices. This feature allows the use of these devices as translators in a mixed 3.3-V/5-V system environment.

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Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

Copyright © 1993–2005, Texas Instruments Incorporated On products compliant to MIL-PRF-38535, all parameters are tested unless otherwise noted. On all other products, production processing does not necessarily include testing of all parameters.

SN54LVC04A, SN74LVC04A HEX INVERTERS

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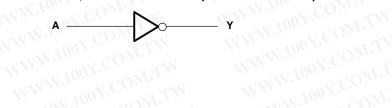
| T _A 100 C | PAC | CKAGE ⁽¹⁾ | ORDERABLE PART NUMBER | TOP-SIDE MARKING | | |
|----------------------|-------------|----------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------------|--|--|
| -40°C to 85°C | QFN – RGY | Reel of 1000 | SN74LVC04ARGYR | LC04A | | |
| VIII | COMMIN | Tube of 50 | SN74LVC04AD | W 100Y. CONTIN | | |
| | SOIC – D | Reel of 2500 | SN74LVC04ADR | LVC04A | | |
| | COM.TW | Reel of 250 | SN74LVC04ADT | NW.100 COM. 1 | | |
| | SOP – NS | Reel of 2000 | SN74LVC04ANSR | LVC04A | | |
| -40°C to 125°C | SSOP - DB | Reel of 2000 | SN74LVC04ADBR | LC04A | | |
| | CONT. | Tube of 90 | SN74LVC04APW | LC04A | | |
| | TSSOP – PW | Reel of 2000 | SN74LVC04APWR | | | |
| | 1007.00.11 | Reel of 250 | SN74LVC04APWT | W 100X.00 | | |
| | TVSOP – DGV | Reel of 2000 | SN74LVC04ADGVR | LC04A | | |
| | CDIP – J | Tube of 25 | SNJ54LVC04AJ | SNJ54LVC04AJ | | |
| -55°C to 125°C | CFP – W | Tube of 150 | of 50 SN74LVC04AD LVC04A of 2500 SN74LVC04ADR LVC04A of 250 SN74LVC04ADR LVC04A of 250 SN74LVC04ADT LVC04A of 2000 SN74LVC04ANSR LVC04A of 2000 SN74LVC04ADBR LC04A of 90 SN74LVC04APW LC04A of 2000 SN74LVC04APWR LC04A of 2000 SN74LVC04APWR LC04A of 2000 SN74LVC04APWT LC04A of 2000 SN74LVC04ADGVR LC04A of 25 SNJ54LVC04AJ SNJ54LVC of 150 SNJ54LVC04AW SNJ54LVC | SNJ54LVC04AW | | |
| | LCCC – FK | Tube of 55 | SNJ54LVC04AFK | SNJ54LVC04AFK | | |

Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at (1) WWW.100Y.COM.TV www.ti.com/sc/package. WWW.100Y

FUNCTION TABLE (EACH INVERTER)

| FUNCT | ON TABLE |
|-------|--------------------|
| (EACH | NVERTER) |
| INPUT | OUTPU ⁻ |
| A | Y |
| H | L |
| | |

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Absolute Maximum Ratings⁽¹⁾

| | erating free-air temperature range (unless | otherwise noted) | | |
|------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------------------------------------------------------|--------------------------|---------|
| | M.M. THE CONT. | WW.Los COMP. | MIN | X UNIT |
| V _{cc} | Supply voltage range | W.IOO COM. | -0.5 6 | .5 V |
| V _I | Input voltage range ⁽²⁾ | 1001. OM.TV | -0.5 6 | .5 V |
| V _O | Output voltage range ⁽²⁾⁽³⁾ | WWW 100Y.CO.ITW | -0.5 V _{CC} + 0 | .5 V |
| I _{IK} | Input clamp current | V ₁ < 0 | WWW.cont | 50 mA |
| I _{OK} | Output clamp current | V ₀ < 0 | - I.WW.Io- | 50 mA |
| I _O | Continuous output current | WW 100Y.COM.TW | 11.11± | 50 mA |
| | Continuous current through V_{CC} or GND | WWWWWWWWWWWWWWWWWWWWWWWWWWWWWWWWWWWWWW | ±1 | 00 mA |
| | CONT. | D package ⁽⁴⁾ | WWW. | 36 |
| | | DB package ⁽⁴⁾ | WW. | 96 |
| 0 | Designed to an a line of the second | DGV package ⁽⁴⁾ | 1: | 27 °C/W |
| θ_{JA} | Package thermal impedance | NS package ⁽⁴⁾ | A AM | 76 |
| | | PW package ⁽⁴⁾ | N N1 | 13 |
| | | RGY package ⁽⁵⁾ | | 17 |
| T _{stg} | Storage temperature range | WWWWWWWWWW | -65 1 | 50 °C |
| P _{tot} | Power dissipation | $T_A = -40^{\circ}C \text{ to } 125^{\circ}C^{(6)(7)}$ | 50 | 00 mW |

Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings (1) only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

The input and output negative-voltage ratings may be exceeded if the input and output current ratings are observed. (2)

(3) The value of V_{CC} is provided in the recommended operating conditions table. The package thermal impedance is calculated in accordance with JESD 51-7. (4)

(5) The package thermal impedance is calculated in accordance with JESD 51-5.

For the D package: above 70°C, the value of P_{tot} derates linearly with 8 mW/K. (6)

For the DB, DGV, NS, and PW packages: above 60°C, the value of Ptot derates linearly with 5.5 mW/K. (7)

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SN54LVC04A, SN74LVC04A HEX INVERTERS

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Recommended Operating Conditions⁽¹⁾

| W | WWW. 100Y.COM TW WWW | 100Y.CO. W.TW WWW | SN54LV | C04A | L.M. |
|-----------------|---------------------------|----------------------------------|----------|-----------------|------|
| | | | –55°C to | 125°C | UNIT |
| | | | MIN | MAX | |
| × | Supply voltage | Operating | 2 | 3.6 | |
| V _{CC} | Supply voltage | Data retention only | 1.5 | 1.00 | v |
| VIH | High-level input voltage | V _{CC} = 2.7 V to 3.6 V | 2 | N.C. | V |
| V _{IL} | Low-level input voltage | V _{CC} = 2.7 V to 3.6 V | WW.IV | 0.8 | V |
| VI | Input voltage | 1002. M.I.V | 0 | 5.5 | V |
| Vo | Output voltage | NW TOOX.CO. TW | 0 | V _{CC} | V |
| | CONTRACTION CONTRACTOR | V _{CC} = 2.7 V | WWW | -12 | CON |
| I _{OH} | High-level output current | V _{CC} = 3 V | VUIT | -24 | mA |
| | | V _{CC} = 2.7 V | | 12 | |
| I _{OL} | Low-level output current | V _{CC} = 3 V | AM | 24 | mA |

 All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

SN74LVC04A T_A = 25°C -40°C to 85°C -40°C to 125°C UNIT MIN MAX MIN MAX MIN MAX Operating 1.65 3.6 1.65 3.6 1.65 3.6 V V_{CC} Supply voltage Data retention only 1.5 1.5 1.5 $V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$ $0.65 \times V_{CC}$ $0.65 \times V_{CC}$ $0.65 \times V_{CC}$ High-level V_{IH} V_{CC} = 2.3 V to 2.7 V 1.7 V 1.7 1.7 input voltage $V_{\rm CC} = 2.7 \text{ V to } 3.6 \text{ V}$ 2 2 2 $0.35 \times V_{CC}$ 0.35 × V_{CC} 0.35 × V_{CC} $V_{CC} = 1.65 \text{ V}$ to 1.95 V Low-level V_{IL} V_{CC} = 2.3 V to 2.7 V 0.7 0.7 0.7 V input voltage $V_{CC} = 2.7 \text{ V} \text{ to } 3.6 \text{ V}$ 0.8 0.8 0.8 VI Input voltage 0 5.5 0 5.5 0 5.5 V V Vo Output voltage 0 0 0 V_{CC} V_{CC} V_{CC} $V_{CC} = 1.65 V$ -4 -4 -4 $V_{CC} = 2.3 V$ -8 -8 -8 High-level mΑ I_{OH} output current $V_{CC} = 2.7 V$ -12 -12 -12 $V_{CC} = 3 V$ -24 -24 -24 V_{CC} = 1.65 V 4 4 4 $V_{CC} = 2.3 V$ 8 8 8 Low-level I_{OL} mΑ output current $V_{CC} = 2.7 V$ 12 12 12 $V_{CC} = 3 V$ 24 24 24

Recommended Operating Conditions (1)

 All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

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SN54LVC04A, SN74LVC04A **HEX INVERTERS**

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Electrical Characteristics

| | COM WWW. COM | WW WN | SN54LVC04A | |
|-----------------|----------------------------------------------------------------|-----------------|--------------------|------|
| PARAMETER | TEST CONDITIONS | V _{cc} | –55°C to 125°C | UNIT |
| | 100Y.COM.TR N. 100Y.COM | A.T. | MIN MAX | |
| WWV | I _{OH} = -100 μA | 2.7 V to 3.6 V | $V_{\rm CC} - 0.2$ | T.M. |
| N ST | | 2.7 V | 2.2 | V |
| V _{OH} | $I_{OH} = -12 \text{ mA}$ | 3 V | 2.4 | OV |
| | $I_{OH} = -24 \text{ mA}$ | 3 V | 2.2 | |
| N | I _{OL} = 100 μA | 2.7 V to 3.6 V | 0.2 | |
| V _{OL} | I _{OL} = 12 mA | 2.7 V | 0.4 | (V) |
| | I _{OL} = 24 mA | 3 V | 0.55 | |
| l _l | $V_{I} = 5.5 \text{ V or GND}$ | 3.6 V | ±5 | μA |
| I _{CC} | $V_{I} = V_{CC}$ or GND, $I_{O} = 0$ | 3.6 V | 10 | μA |
| ΔI_{CC} | One input at V_{CC} – 0.6 V, Other inputs at V_{CC} or GND | 2.7 V to 3.6 V | 500 | μΑ |

Electrical Characteristics

| | WWW.10 | V CONT. | | WW | S | N74LVC04A | I'm | | NN | 4.0 |
|-----------------|-----------------------------------------------------------------|-----------------|------------------|--------|---------|----------------|------|----------------|-------|------|
| PARAMETER | TEST CONDITIONS | Vcc | T _A : | = 25°C | 1.10 | -40°C to | 85°C | -40°C to ' | 125°C | UNIT |
| | WW 10 | | MIN | TYP | MAX | MIN | MAX | MIN | MAX | |
| | I _{OH} = -100 μA | 1.65 V to 3.6 V | $V_{CC} - 0.2$ | WV | | $V_{CC} - 0.2$ | - | $V_{CC} - 0.3$ | | |
| | $I_{OH} = -4 \text{ mA}$ | 1.65 V | 1.29 | N. | M.M. | 1.2 | Our | 1.05 | N. | |
| N/ | I _{OH} = -8 mA | 2.3 V | 1.9 | | | 1.7 | -0M | 1.55 | | V |
| V _{OH} | 1 10 m 4 | 2.7 V | 2.2 | | | 2.2 | | 2.05 | | V |
| | $I_{OH} = -12 \text{ mA}$ | 3 V | 2.4 | | MM | 2.4 | .00 | 2.25 | | |
| | I _{OH} = -24 mA | 3 V | 2.3 | | W | 2.2 | V.CO | 2 | | |
| | I _{OL} = 100 μA | 1.65 V to 3.6 V | ON.L. | r | 0.1 | W.IO | 0.2 | DW. | 0.3 | |
| | I _{OL} = 4 mA | 1.65 V | VI.IV | | 0.24 | 10 | 0.45 | MIT | 0.6 | |
| V _{OL} | I _{OL} = 8 mA | 2.3 V | Contra | N | 0.3 | NN | 0.7 | T | 0.85 | V |
| | I _{OL} = 12 mA | 2.7 V | CONL | | 0.4 | WW. | 0.4 | COM | 0.6 | |
| | I _{OL} = 24 mA | 3 V | COM | | 0.55 | W | 0.55 | - COM. | 0.8 | |
| I _I | $V_{I} = 5.5 \text{ V or GND}$ | 3.6 V | Y.Com | IN | ±1 | WW | ±5 | Mon | ±20 | μA |
| I _{CC} | $V_{I} = V_{CC}$ or GND, $I_{O} = 0$ | 3.6 V | N.COM | WT | 1 | WWY | 10 | N.Co. | 40 | μΑ |
| ΔI_{CC} | One input at $V_{CC} - 0.6 V$, Other inputs at V_{CC} or GND | 2.7 V to 3.6 V | 00Y.COM | M.TV | 500 | WW | 500 | DOX.COR | 5000 | μA |
| Ci | $V_{I} = V_{CC}$ or GND | 3.3 V | 100 1. | 5 | 4 1 | | Wa | In the | 01. | pF |

| C_i $V_i = V_{CC} o$ | r GND 3 | 3.3 V 5 | | WILL | COM | pF |
|------------------------|---------|------------------------------|----------------------|---------|-----|------|
| Switching Characte | | ture range (unless otherwise | e noted) (see Figure | 1) | | |
| PARAMETER | FROM | TO TO | V _{cc} | SN54LVC | - | UNIT |
| TANAMETER | (INPUT) | (OUTPUT) | C C CC | MIN | MAX | UNIT |
| | А | V | 2.7 V | | 5.5 | 20 |
| t _{pd} | A | | 3.3 V ± 0.3 V | 0.5 | 4.5 | ns |

SN54LVC04A, SN74LVC04A HEX INVERTERS

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Switching Characteristics

| PARAMETER | SI CON | - Arm | WWW. | V.CU | - 1 | S S | N74LVC | 04A | .Yook | | |
|--------------------|----------|----------------|-----------------|-------|---------------------|-----|----------|--------|----------|-------|------|
| | (INPUT) | TO (OUTPUT) | V _{cc} | т, "т | _A = 25°C | | –40°C te | o 85°C | –40°C to | 125°C | UNIT |
| | (111 01) | (001101) | | MIN | TYP | MAX | MIN | MAX | MIN | MAX | 1.1 |
| WW | | WT | 1.8 V ± 0.15 V | .001. | 4.1 | 7.5 | 1 | 8 | 10 | 9.5 | TIM |
| | W.100 | DNL | 2.5 V ± 0.2 V | 1 | 3.6 | 7 | 1 | 7.5 | 1 | 9 | |
| t _{pd} | Aor | OM.T. | 2.7 V | 1.101 | 3 | 5.3 | 1 | 5.5 | 111 | 7 | ns |
| W | 1001.00 | WIN | 3.3 V ± 0.3 V | 10 | 2.5 | 4.3 | 1 | 4.5 | 1.1 | 6 | |
| t _{sk(o)} | NN. | Comm | 3.3 V ± 0.3 V | | N.C. | | W | 1 | NN I | 1.5 | ns |

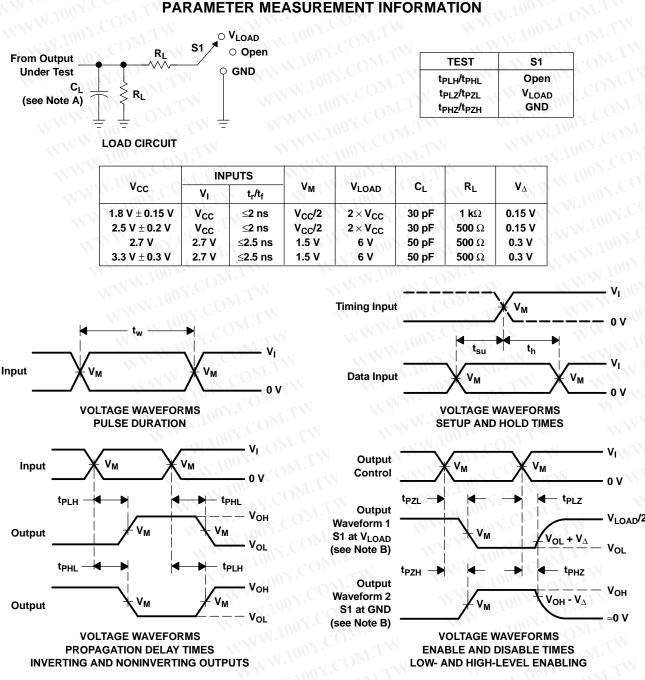
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Operating Characteristics

| | PARAMETER | CONDITIONS | V _{cc} | TYP | UNIT |
|---|----------------------------------------|------------|-----------------|-----|-------|
| | TWW.100 S COM. | W.IVY COM. | 1.8 V | 6 | loo V |
| d | Power dissipation capacitance per gate | f = 10 MHz | 2.5 V | 7 | pF |
| | | 1001. JUNI | 1.8 V | 8 | |

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|------------------------------|-------------|------------|
| 胜特力电子(深圳) 86 | | |
| Http://www.10 | 0y. com. tw | W.100X.CO |



- NOTES: A. C_L includes probe and jig capacitance.
 - B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
 C. All input pulses are supplied by generators having the following characteristics: PRR ≤ 10 MHz, Z_Ω = 50 Ω.
 - D. The outputs are measured one at a time, with one transition per measurement.
 - E. t_{PLZ} and t_{PHZ} are the same as t_{dis} .
 - F. t_{PZL} and t_{PZH} are the same as t_{en} .
 - G. t_{PLH} and t_{PHL} are the same as t_{pd} .
 - H. All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms

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PACKAGE OPTION ADDENDUM

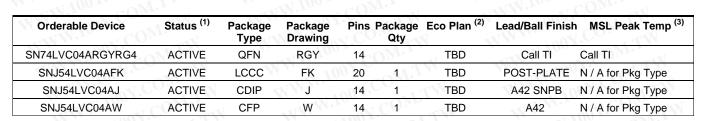
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PACKAGING INFORMATION

| Orderable Device | Status ⁽¹⁾ | Package | Package Drawing | Pins | | e Eco Plan ⁽²⁾ | Lead/Ball Finish | MSL Peak Temp ⁽³⁾ |
|------------------|-----------------------|--------------|--------------------|------|----------|---------------------------|------------------|------------------------------|
| 5962-9760501Q2A | ACTIVE | Type LCCC | FK | 20 | Qty 1 | TBD | POST-PLATE | N / A for Pkg Type |
| 5962-9760501QCA | ACTIVE | CDIP | J | 14 | _1 | TBD | A42 SNPB | N / A for Pkg Type |
| 5962-9760501QDA | ACTIVE | CFP | W | 14 | 1 | TBD | A42 | N / A for Pkg Type |
| SN74LVC04AD | ACTIVE | SOIC | D | 14 | 50 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVC04ADBLE | OBSOLETE | SSOP | DB | 14 | N.0- | TBD | Call TI | Call TI |
| SN74LVC04ADBR | ACTIVE | SSOP | DB | 14 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVC04ADBRG4 | ACTIVE | SSOP | DB | 14 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVC04ADE4 | ACTIVE | SOIC | D | 14 | 50 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVC04ADGVR | ACTIVE | TVSOP | DGV | 14 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVC04ADGVRE4 | ACTIVE | TVSOP | DGV | 14 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVC04ADR | ACTIVE | SOIC | T D | 14 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVC04ADRE4 | ACTIVE | SOIC | D | 14 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVC04ADRG4 | ACTIVE | SOIC | D | 14 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVC04ADT | ACTIVE | SOIC | D | 14 | 250 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVC04ADTE4 | ACTIVE | SOIC | D.T | 14 | 250 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVC04ANSR | ACTIVE | SO | NS | 14 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVC04ANSRG4 | ACTIVE | SO | NS | 14 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVC04APW | ACTIVE | TSSOP | PW | 14 | 90 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVC04APWE4 | ACTIVE | TSSOP | PW | 14 | 90 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVC04APWG4 | ACTIVE | TSSOP | PW | 014 | 90 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVC04APWLE | OBSOLETE | TSSOP | PW | 14 | . · | TBD | Call TI | Call TI |
| SN74LVC04APWR | ACTIVE | TSSOP | PW | 14 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVC04APWRE4 | ACTIVE | TSSOP | PW | 14 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVC04APWRG4 | ACTIVE | TSSOP | PW | 14 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVC04APWT | ACTIVE | TSSOP | PW | 14 | 250 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVC04APWTE4 | ACTIVE | TSSOP | PW | 14 | 250 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVC04ARGYR | ACTIVE | QFN | RGY | 14 | 1000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-2-260C-1YEAR |

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⁽¹⁾ The marketing status values are defined as follows:

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ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details. TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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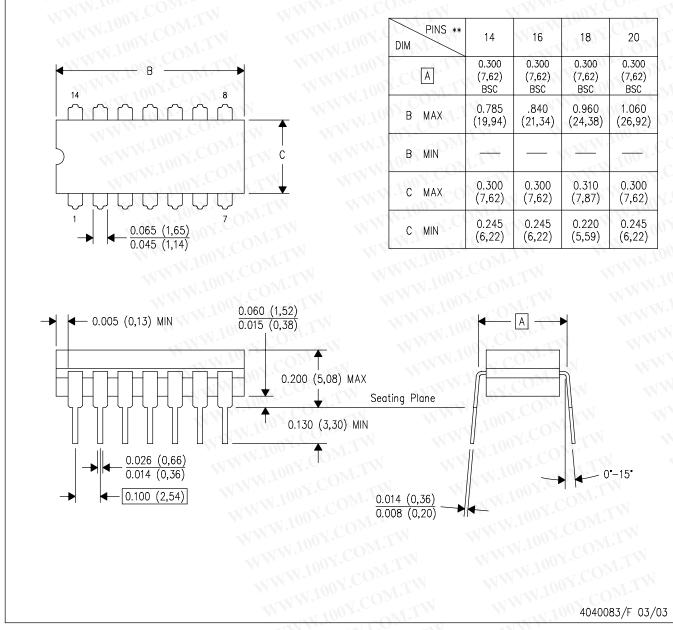
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J(R-GDIP-T**)

CERAMIC DUAL IN-LINE PACKAGE

14 LEADS SHOWN



NOTES: A. All linear dimensions are in inches (millimeters).

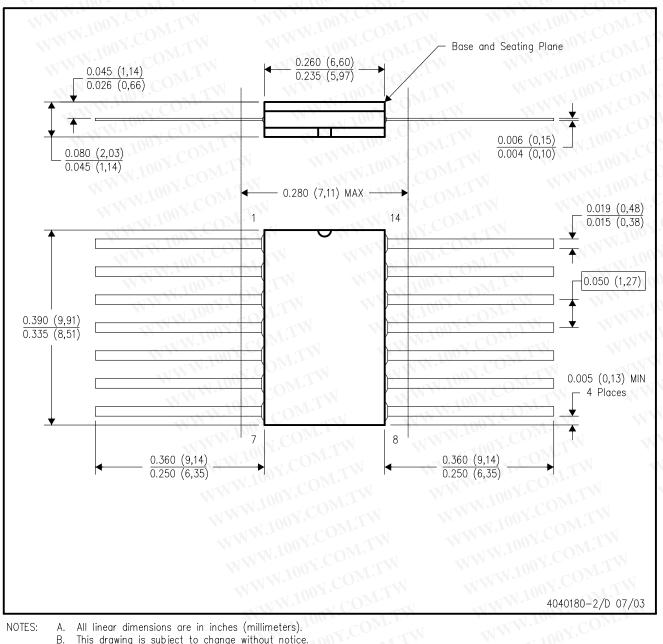
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.



WWW.100Y.COM. **MECHANICAL DATA**

CERAMIC DUAL FLATPACK

W (R-GDFP-F14)



- Β.
- This drawing is subject to change without notice. This package can be hermetically said to the metically said to the metical This package can be hermetically sealed with a ceramic lid using glass frit. C.
- D. Index point is provided on cap for terminal identification only.
- WWW.100Y.COM.TW E. Falls within MIL STD 1835 GDFP1-F14 and JEDEC MO-092AB

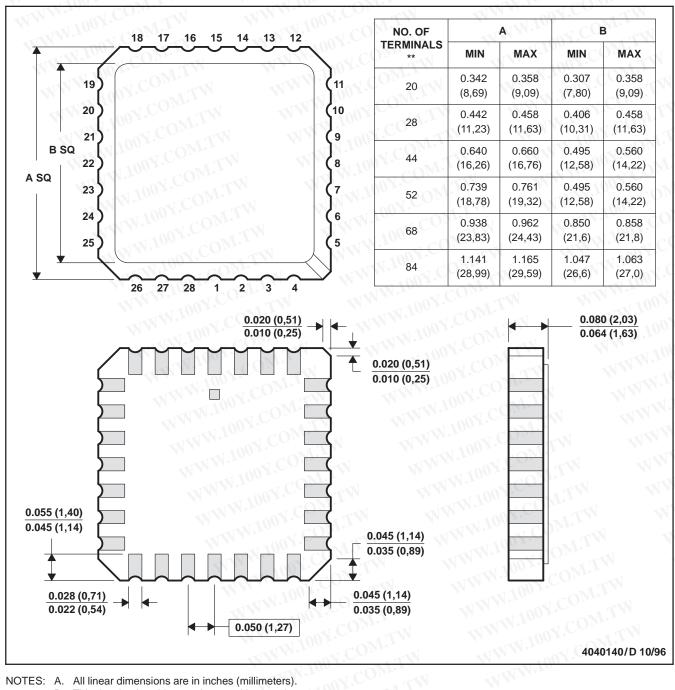


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MLCC006B - OCTOBER 1996

LEADLESS CERAMIC CHIP CARRIER

FK (S-CQCC-N**) **28 TERMINAL SHOWN**



NOTES: A. All linear dimensions are in inches (millimeters).

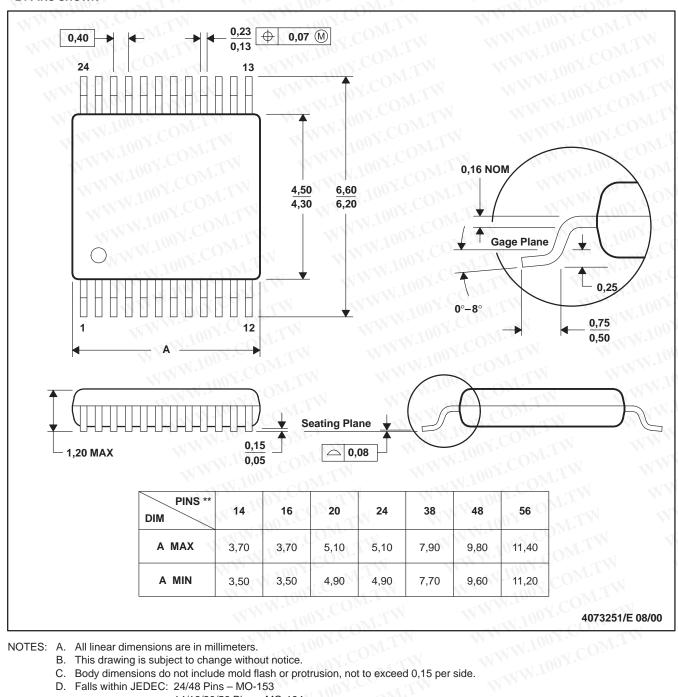
- C. This package can be hermetically sealed with a metal lid.
 D. The terminals are gold plated. WWW.100Y.COM.TW
- E. Falls within JEDEC MS-004



MPDS006C - FEBRUARY 1996 - REVISED AUGUST 2000

DGV (R-PDSO-G**) **24 PINS SHOWN**

PLASTIC SMALL-OUTLINE



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.
- D. Falls within JEDEC: 24/48 Pins MO-153

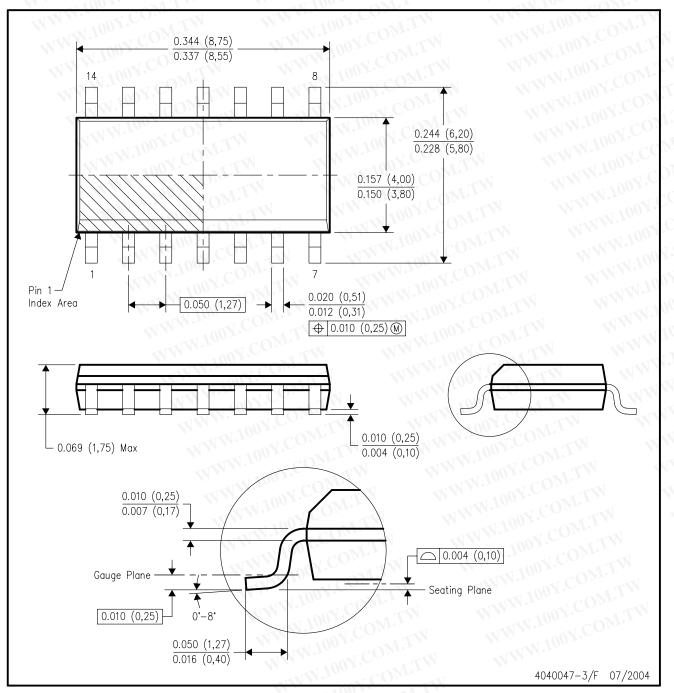
WWW.100Y.COM WWW.100Y.COM.TW 14/16/20/56 Pins - MO-194





D (R-PDSO-G14)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-012 variation AB.



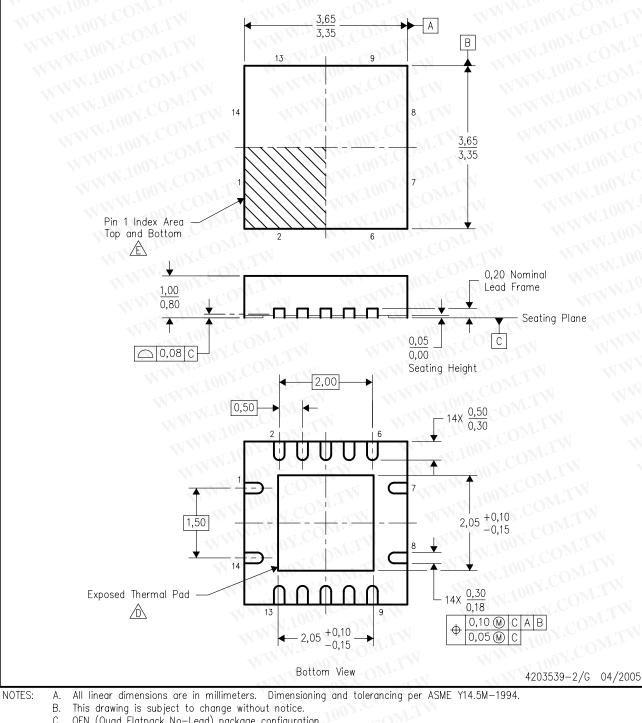


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WWW.100Y.COM! **MECHANICAL DATA**

PLASTIC QUAD FLATPACK





- QFN (Quad Flatpack No-Lead) package configuration. C.
- / m b The package thermal pad must be soldered to the board for thermal and mechanical performance.
- Æ Pin 1 identifiers are located on both top and bottom of the package and within the zone indicated. The Pin 1 identifiers are either a molded, marked, or metal feature.
- F. Package complies to JEDEC MO-241 variation BA.



TEXAS INSTRUMENTS www.ti.com

THERMAL PAD MECHANICAL DATA

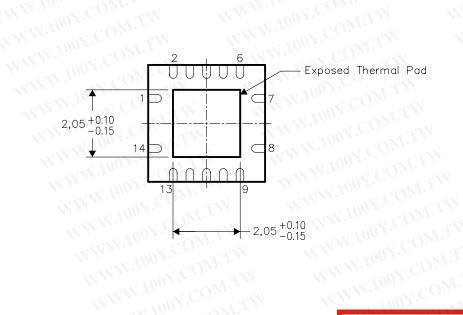
RGY (S-PQFP-N14)

THERMAL INFORMATION

This package incorporates an exposed thermal pad that is designed to be attached directly to an external heatsink. The thermal pad must be soldered directly to the printed circuit board (PCB), the PCB can be used as a heatsink. In addition, through the use of thermal vias, the thermal pad can be attached directly to a ground plane or special heatsink structure designed into the PCB. This design optimizes the heat transfer from the integrated circuit (IC).

For information on the Quad Flatpack No-Lead (QFN) package and its advantages, refer to Application Report, Quad Flatpack No-Lead Logic Packages, Texas Instruments Literature No. SCBA017. This document is available WWW.100Y.COM.TW at www.ti.com.

The exposed thermal pad dimensions for this package are shown in the following illustration.



WWW.100Y.COM Bottom View

NOTE: All linear dimensions are in millimeters

100Y.COM. Exposed Thermal Pad Dimensions WWW.100Y.COM

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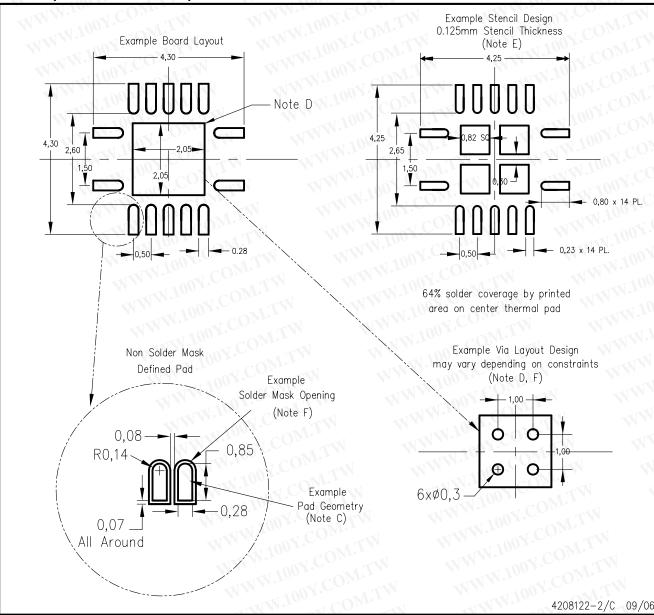
WWW.100Y.C

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LAND PATTERN

RGY (R-PQFP-N14)



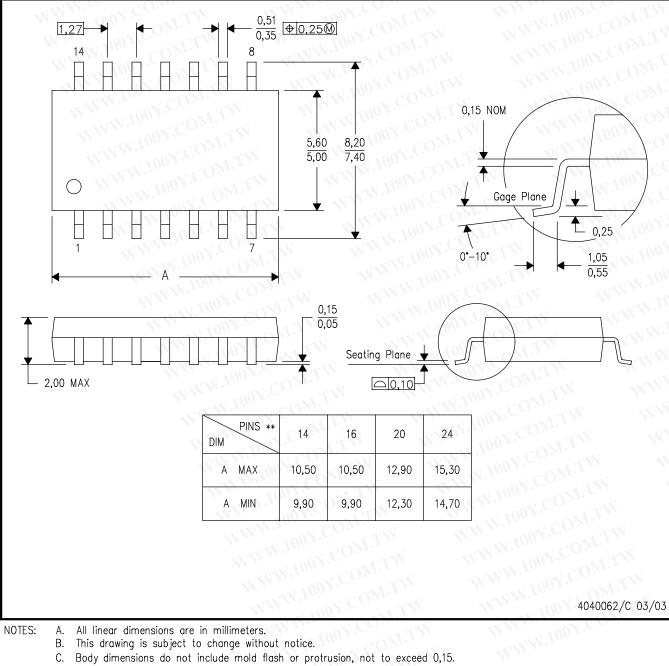
NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. This package is designed to be soldered to a thermal pad on the board. Refer to Application Note, Quad Flat-Pack Packages, Texas Instruments Literature No. SCBA017, SLUA271, and also the Product Data Sheets for specific thermal information, via requirements, and recommended board layout. These documents are available at www.ti.com <http://www.ti.com>.
- E. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC 7525 for stencil design considerations.
- F. Customers should contact their board fabrication site for minimum solder mask web tolerances between signal pads.



PLASTIC SMALL-OUTLINE PACKAGE

NS (R-PDSO-G**) **14-PINS SHOWN**



NOTES: All linear dimensions are in millimeters. Α.

- This drawing is subject to change without notice. Β.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

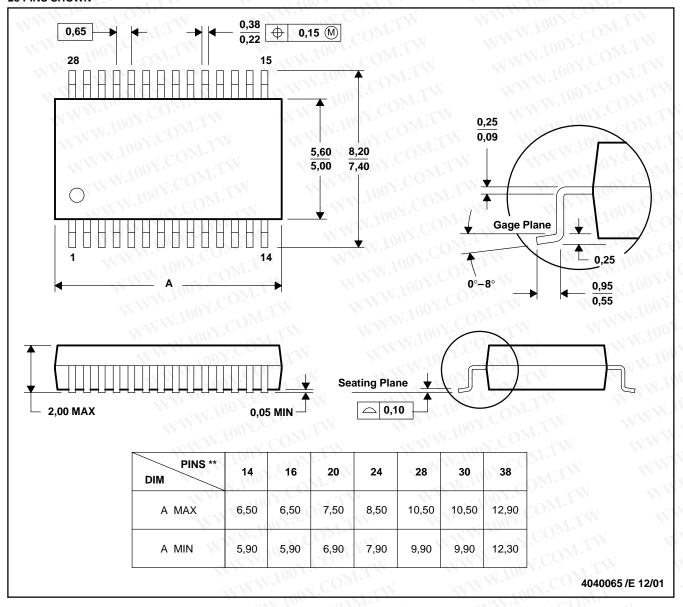
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MSSO002E - JANUARY 1995 - REVISED DECEMBER 2001

PLASTIC SMALL-OUTLINE

DB (R-PDSO-G**) 28 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
- D. Falls within JEDEC MO-150

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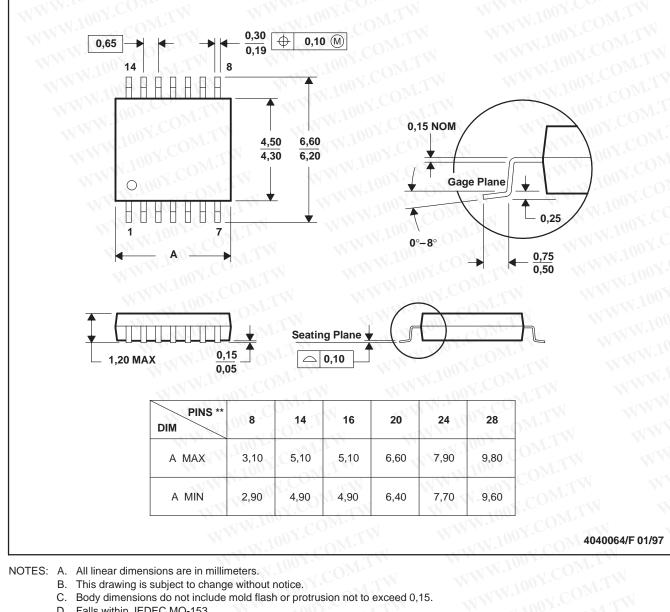


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MTSS001C - JANUARY 1995 - REVISED FEBRUARY 1999

PLASTIC SMALL-OUTLINE PACKAGE

PW (R-PDSO-G**) **14 PINS SHOWN**



NOTES: A. All linear dimensions are in millimeters.

- This drawing is subject to change without notice. В.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
- D. Falls within JEDEC MO-153



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